

2/22/12

RECORD/  
P.



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1. Name of conveying party(ies):

Krishnamurthy Viswanathan  
Choudur Lakshminarayan  
Wade J Satterfield  
Vanish Talwar  
Chengwei Wang

party(ies):

HEWLETT-PACKARD DEVELOPMENT COMPANY, L.P.  
11445 Compaq Center Drive West  
Houston, TX 77070



Additional name(s) of conveying party(ies) attached?  Yes  No  
Additional name(s) and address(es) attached?  Yes  No

3. Nature of Conveyance:

Assignment       Merger       Change of Name       Security Agreement       Joint  
 Other

Execution Date(s): 10/31/2011, 10/31/2011, 10/31/2011, 10/31/2011, 10/31/2011

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, execution date of the application is:

A. Patent Application No.(s)

Application No.: 13/286150

Date Filed: Oct 31, 2011

Confirmation No.:

B. Patent No.(s):

Additional numbers attached? NO

5. Name and address of party to whom correspondence concerning document should be mailed:

Records Manager  
Intellectual Property Administration  
HEWLETT-PACKARD COMPANY  
3404 E. Harmony Road  
Mail Stop 35  
Fort Collins, Colorado 80528

6. Total number of applications and patents involved: 1

7. Total Fee (37 CFR 3.41): ..... \$40.00

Enclosed

Authorization to be charged to deposit account.

8. Deposit Account Number: 08-2025

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Debbie Syrmis  
Name of Person Signing

*Debbie Syrmis*  
Signature

02/22/2012 AMULLINS 00000018 082025  
February 14, 2012  
01 FC:0021 DEB DA

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Total number of pages including coversheet, attachments, and documents: 10

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:  
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, V.A. 22313-1450

HEWLETT-PACKARD COMPANY  
Intellectual Property Administrator  
3404 E. Harmony Road  
Mail Stop 35  
Fort Collins, Colorado 80528

PATENT APPLICATION

PATENT REFERENCE: 82816048

**ASSIGNMENT OF PATENT APPLICATION**

I/We, the undersigned (each) have agreed and hereby agree to assign to HEWLETT-PACKARD DEVELOPMENT COMPANY, L.P., a Texas Limited Partnership, having its principal place of business in Houston, Texas; (hereinafter HPDC); in furtherance of my/our obligations to the Hewlett-Packard Company and its subsidiaries and affiliates, and do hereby assign and transfer to HPDC, its successors and assigns, the entire right, title and interest, including the right of priority, in, to and under an application for Letters Patent of the United States entitled:

**SYSTEM AND METHOD FOR RANKING ANOMALIES**

Filing Date: October 31, 2011

Application No.: 13/286,150

and the invention(s) and improvement(s) set forth therein, and any and all continuations, continuations-in-part (C-I-P's), divisionals, and renewals of and substitutes for said application for said Letters Patent, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefore; and any reissues, or reexaminations, or extensions of said Letters Patent.

I/we additionally authorize HPDC to file applications in my/our name for Letters Patent in any country, to be held and enjoyed by HPDC, its successors, assigns, nominees or legal representatives, to the full end of the term or terms for which said Letters Patent respectively may be granted, reissued or extended, as fully and entirely as the same would have been held and enjoyed by me/us had this assignment, and transfer not been made.

AND I/we hereby covenant that I/we have full right to convey the entire interest herein assigned, and that I/we have not executed and will not execute any agreement in conflict herewith, and I/we further covenant and agree that I/we will, each time a request is made, and without undue delay, execute and deliver all such papers as may be necessary or desirable to perfect the title to said invention(s) or improvement(s), said application and said Letters Patent, to HPDC, its successors, assigns, nominees or legal representatives, and I/we agree to communicate to HPDC, or to its nominee, all known facts respecting said invention(s) or improvement(s), said application and said Letters Patent, to testify in any legal proceedings, to sign all lawful papers, to execute all disclaimers and divisionals, continuations, C-I-P's, reissue and foreign applications, to make all rightful oaths and declarations, and generally to do everything possible to aid HPDC, its successors, assigns, nominees and legal representatives to obtain and enforce, for its or their own benefit, proper patent protection for said invention(s) or improvement(s) in any and all countries provided the expenses which may be incurred by me/us in lending such cooperation and assistance are paid by HPDC.

AND I/we hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any country or countries foreign to the United States whose duty it is to issue patents on applications as aforesaid, to issue to HPDC, as assignee of the entire right, title and interest, any and all Letters Patent for said invention(s) or improvement(s), including any and all Letters Patent of the United States which may be issued and granted on or as a result of the application aforesaid, in accordance with the terms of this assignment.

I/we further authorize and direct the attorneys of record to insert the serial number and filing date of said application now identified by the attorney docket number and title set forth above as soon as the same shall have been made known to them by the United States Patent and Trademark Office.

V. Krishnamurthy  
Inventor's Signature: \_\_\_\_\_ Date Assignment Signed: 10/31/2011

Krishnamurthy VISWANATHAN  
Inventor's Typed Name: \_\_\_\_\_ Date Application Signed: 10/31/2011

\_\_\_\_\_  
Inventor's Signature \_\_\_\_\_ Date Assignment Signed \_\_\_\_\_

Choudur LAKSHMINARAYAN  
Inventor's Typed Name \_\_\_\_\_ Date Application Signed \_\_\_\_\_

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Intellectual Property Administrator  
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PATENT REFERENCE: 82816048

ASSIGNMENT OF PATENT APPLICATION (cont.)

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Wade J. SATTERFIELD  
Inventor's Typed Name \_\_\_\_\_ Date Application Signed \_\_\_\_\_

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Vanish TALWAR  
Inventor's Typed Name \_\_\_\_\_ Date Application Signed \_\_\_\_\_

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Chengwei WANG  
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**SYSTEM AND METHOD FOR RANKING ANOMALIES**

Filing Date: October 31, 2011 Application No.: 13/286,150

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Krishnamurthy VISWANATHAN _____ Inventor's Typed Name	_____ Date Application Signed
<i>Choudur Lakshminarayan</i> _____ Inventor's Signature	<u>10/31/2011</u> _____ Date Assignment Signed
Choudur LAKSHMINARAYAN _____ Inventor's Typed Name	<u>10/31/2011</u> _____ Date Application Signed

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ASSIGNMENT OF PATENT APPLICATION (cont.)

*Wade Satterfield*

Inventor's Signature

*31-Oct-2011*

Date Assignment Signed

Wade J. SATTERFIELD

Inventor's Typed Name

*31-Oct-2011*

Date Application Signed

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Inventor's Typed Name

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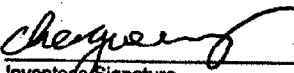
ASSIGNMENT OF PATENT APPLICATION (cont.)

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